F4280 Technology of Thin Film Deposition & Surface Treatments 10. PECVD

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### Outline

### • 10. PECVD

10.4 Plasma Polymerization Understanding the Plasma Polymerization Plasma Polymerization in Pulsed RF Discharges Amine Plasma Polymers Carboxyl Plasma Polymers

### **10.4 Plasma Polymerization**

### Plasma polymerization is a subset of plasma enhanced CVD

It produces organic thin films with specific functional groups originating from the monomer structure.

Plasma polymers **do not have the typical structure of polymers** (impossible to find a repeated unit, structure is highly branched and cross-linked).

Yasuda scheme:



1st pathway ( $M^{\bullet}$ ) - similar to a standard free radical polymerization mechanism, 2nd pathway ( $\bullet M^{\bullet}$ ) - difunctional mechanism, "polymer" can grow in multiple directions by multiple pathways off one species  $\Rightarrow$  a very rapid step-growth polymerization:

### Organosilicon plasma polymers

#### hexamethyldisiloxane

 $\begin{array}{ccc} CH_3 & CH_3 \\ H_3C-Si-O-Si-CH_3 \\ CH_3 & CH_3 \end{array}$ 

#### Carboxyl/ester/anhydride films



- barrier and protective coatings
- hydrophilic/hydrophobic surface
- cross-linking improvement (stabilization of organic functionalities by co-polymerization)
- interfacial adhesion,
- grafting of molecules with specific functionalities (reverse adhesion),
- improvement of cell colonization (tissue engineering),
- immobilization of biomolecules (biosensors, drug delivery systems).
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Description of plasma polymerization by macroscopic kinetic approach

involving a composite ("Yasuda") parameter W/F (W power, F monomer flow rate) proportional to the energy delivered per one molecule of monomer in gas phase

D. Hegemann et al. Plasma Process Polym 7 (2010) 889

$$\begin{aligned} \frac{R_{\rm m}}{F} &= G \exp\left(-\frac{E_{\rm a}}{W/F|_{\rm dep}}\right) \\ \frac{W}{F}|_{\rm dep} &= \frac{W}{F} \frac{d_{\rm act}}{d_{\rm gas}} \end{aligned} \tag{1}$$

mass deposition rate  $R_{\rm m}$ , apparent activation energy  $E_{\rm a}$ , absorbed power density W, gas flow F Arrhenius plot - describing gas-phase processes:



(again for the example of plasma polymerization of HMDSO in CCP)

Effect of ion bombardment (plasma-surface interaction) should not be forgotted, especially for low pressure CCP discharges!

and its not only about the ion energy - it is about ion energy flux

Energy dissipated per deposition rate R

$$\varepsilon_{\rm surf} = \frac{\Gamma_i E_{\rm mean}}{R}$$

 $\Gamma_i$  ion flux,  $E_{mean}$  mean ion energy

D. Hegemann et al. Appl. Phys. Lett. 101 (2012) 211603



(again for the example of plasma polymerization of HMDSO in CCP)

### 10.4.2 Plasma Polymerization in Pulsed RF Discharges

Quest for retaining monomer structure in plasma polymers - too much energy in plasmas!

- decreasing power (some limits apply)
- excluding ion energy flux (higher pressures, atmospheric pressure namely)
- pulsed CCP discharges



pulse repetition frequency

$$f_{\rm puls} = 1/(t_{\rm on} + t_{\rm off})$$

duty cycle (DC)  $DC = rac{t_{
m on}}{t_{
m on}+t_{
m off}} imes 100\%$ 

Simplification (1 parameter instead of 2): mean RF power  $P_{\text{aver}} = P_{\text{on}} \times DC$ 

 $\Rightarrow$  Macroscopic approach uses  $P_{\rm aver}$ 

$$W/F = rac{P_{\mathrm{aver}}}{Q} ~ [\mathrm{J/cm^3}]$$



cells interaction with surfaces (artificial tissue engineering)



Cells interact with surfaces via extracellular matrix (ECM)



ECM contains proteins like fibronectine that bonds well to protonated surfaces such as  $NH_2$  surfaces at neutral pH.



#### Plasma polymerization - alternative to the conventional methods



Example of plasma polymerized cyclopropylamine optimized for sensing performace



Surface plasma treatment, e.g. in N<sub>2</sub> or NH<sub>3</sub> discharges  $\Rightarrow$  unstable functionalization of a thin near-surface layer with rather short duration

Deposition from vapors of amine monomers:

- allylamine
- diaminocyclohexane
- ethylenediamine
- cyclopropylamine (CPA)
- etc.

usually in pulsed RF discharges, substrate floating or grounded

#### Deposition from gas mixtures:

- NH<sub>3</sub>/CH<sub>4</sub>
- NH<sub>3</sub>/C<sub>2</sub>H<sub>4</sub>

usually in continuous wave RF discharges, substrate at RF electrode

Allylamine - commonly used due to presence of vinyl group (free radical polymerization) but highly toxic flammable chemical compound



Cyclopropylamine - promising monomer for amine-rich coatings, non-toxic, vapor pressure of 32 kPa at 25 °C.



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## **CPA Plasma Polymerization at Low Pressure**

- ▶ in RF (13.56 MHz) capacitively coupled discharges
- continuous wave and pulsed modes
  - ►  $t_{\rm on} = 660 \,\mu {
    m s}, \, t_{\rm off} = 1340 \,\mu {
    m s} \Rightarrow$
  - $f_{\rm puls} = 500 \,\text{Hz}, DC = 33 \,\%$

#### reactor R3, substrate at floating potential



- Ar 28 sccm, CPA 0.1–1.0 sccm
- pressure 120 Pa
- RF power 20–30 W
- electrode diameter 80 mm
- interelectrode distance 185 mm

in CPA/Ar mixtures

#### reactor R2, substrate at RF electrode



- $Q(Ar) = 28 \operatorname{sccm}, Q(CPA) = 2.0 \operatorname{sccm}$
- pressure 50 Pa
- RF power 30–250 W
- electrode diameter 420 mm
- interelectrode distance 55 mm

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### 10.4.4 Carboxyl Plasma Polymers



Plasma processing of carboxyl plasma polymers by PECVD from simple molecules

- H<sub>2</sub>O / CO<sub>2</sub> [1]
- C<sub>2</sub>H<sub>4</sub> / CO<sub>2</sub> [2]

by plasma (co-)polymerization of COOH-based monomers

- acrylic acid (AA) [2,3,4]
- maleic anhydride (MA) [5,6]



maleic anhydride

- [1] N. Medard, J.-C Soutif, F. Poncin-Epaillard, Langmuir, 2002, 18, 2246
- [2] D. Hegemann, E. Koerner, S. Guimond Plasma Process. Polym. 2009, 6, 246
- [3] L. Detomasso, R. Gristina, G. Senesi, R. d'Agostino, P. Favia, Biomaterials 2005, 26, 3831
- [4] A. Fahmy, R.Mix, A. Schonhals, J. Friedrich Plasma Process. Polym. 2011, 8, 147
- [5] A. Manakhov, M. Moreno-Couranjou, N. D. Boscher et al., Plasma Process. Polym. 9 (2012) 435
- [6] M. M. Brioude, M.-P. Laborie, A. Airoudj et al., Plasma Process. Polym. 12 (2015) 1220

## **COOH-Films** Deposited at Atmospheric Pressure

### DBD plasma polymerization of acryic acid in He

A.J. Beck, R.D. Short, A. Matthews, Surf Coat Technol 203 (2008) 822–825:

- ▶ percentage of functional groups by fitting XPS C1s signal (~ 289.3 eV binding energy for <u>C</u>(O)=O, i.e. carboxyl and ester groups)
- Films with high retention of the monomer structure for low energetic conditions (low W/F) ⇒ up to 29.7 % of COOR
- Bioapplications require sufficient stability in aqueous media but cross-linking improves the layer stability at expenses of the functional group concentration.
- Plasma co-polymerization offers an additional possibility to tune the film stability and carboxyl functionalization efficiency

Thomas et al. Plasma Process. Polym. 4 (2007) S475 Manakhov et al. PPP 9 (2012) 435 - copolymerization of maleic anhydride (MA) and vinyltrimethoxysilane (VTMOS) in DBD





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### **Co-polymerization of MA and C<sub>2</sub>H<sub>2</sub>**

- dielectric barrier discharge at 6.6 kHz, 12 W
- distance between dielectrics 1.6 mm
- top electrode made of two parts, each 55 × 20 mm, spaced by 20 mm
- rectangular bottom electrode 150 × 60 mm
- central gas inlet, 9 mm in diameter
- buffer chamber distributing gas flow into a slit, 2 mm wide and 48 mm long



MA :  $C_2H_2$  flow rate ratio varied by changing flow rate of  $C_2H_2$  and Ar through MA.

- $\blacktriangleright\,$  Ar flow rate through MA bubbler  ${\it Q}_{\rm Ar-MA}=0.25\text{--}1.5\,\text{slm}\Rightarrow {\it Q}_{\rm MA}=0.06\text{--}0.33\,\text{sccm}$
- $C_2H_2$  flow rate  $Q_{C2H2} = 2-3$  sccm
- total Ar flow rate  $Q_{\rm Ar-MA} + Q_{\rm Ar} = 1.5 \, \rm slm$